

SCTWA20N120

Silicon carbide Power MOSFET 1200 V, 20 A, 189 m Ω (typ., T_J=150 °C) N-channel in a HiP247 long leads package

Datasheet - preliminary data

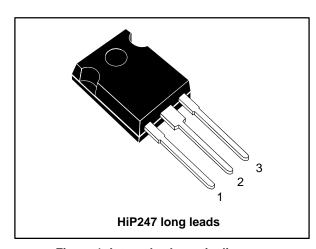
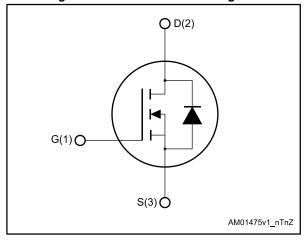


Figure 1: Internal schematic diagram



Features

- Very tight variation of on-resistance vs. temperature
- Slight variation of switching losses vs. temperature
- Very high operating temperature capability (T_J = 200 °C)
- Very fast and robust intrinsic body diode
- Low capacitance

Applications

- Solar inverters, UPS
- Motor drives
- High voltage DC-DC converters
- Switch mode power supplies

Description

This silicon carbide Power MOSFET is produced exploiting the advanced, innovative properties of wide bandgap materials. This results in unsurpassed on-resistance per unit area and very good switching performance almost independent of temperature. The outstanding thermal properties of the SiC material allows designers to use an industry-standard outline with significantly improved thermal capability. These features render the device perfectly suitable for high-efficiency and high power density applications.

Table 1: Device summary

Order code	Marking	Package	Packaging
SCTWA20N120	SCT20N120	HiP247 long leads	Tube



The device meets ECOPACK standards, an environmentally-friendly grade of products commonly referred to as "halogen-free". See *Section 6: "Package information"*.

June 2016 DocID029417 Rev 1 1/12

Contents SCTWA20N120

Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Packag	e information	9
	3.1	HiP247 long leads package information	9
4	Revisio	n history	11

SCTWA20N120 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	1200	V
V _{GS}	Gate-source voltage	-10 to 25	V
I _D	Drain current (continuous) at T _C = 25 °C	20	Α
I _D	Drain current (continuous) at T _C = 100 °C	16	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	45	Α
Ртот	Total dissipation at T _C = 25 °C	175	W
T _{stg}	Storage temperature range	55 to 200	°C
Tj	Operating junction temperature range	-55 to 200	°C

Notes:

Table 3: Thermal data

Symbol	Symbol Parameter		Unit
R _{thj-case}	Thermal resistance junction-case max		°C/W
R _{thj-amb}	R _{thj-amb} Thermal resistance junction-ambient max		°C/W

⁽¹⁾Pulse width limited by safe operating area.

Electrical characteristics SCTWA20N120

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified).

Table 4: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	Zero gate voltage	V _{DS} = 1200 V, V _{GS} = 0 V			100	μΑ
IDSS	drain current	V _{DS} = 1200 V, V _{GS} = 0 V, T _J = 200 °C		50		μΑ
Igss	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = 22 to -10 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$	2	3.5		V
		$V_{GS} = 20 \text{ V}, I_{D} = 10 \text{ A}$		169	239	mΩ
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 20 \text{ V}, I_D = 10 \text{ A},$ $T_J = 150 \text{ °C}$		189		mΩ
		V _G S = 20 V, I _D = 10 A, T _J = 200 °C		220		mΩ

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	650	-	pF
Coss	Output capacitance	$V_{DS} = 400 \text{ V}, f = 1 \text{ MHz},$	-	65	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0 V		14	-	pF
Qg	Total gate charge	N 000 V I 40 A	-	45	-	nC
Qgs	Gate-source charge	$V_{DD} = 800 \text{ V}, I_{D} = 10 \text{ A},$ $V_{GS} = 0 \text{ to } 20 \text{ V}$	-	7	-	nC
Q _{gd}	Gate-drain charge	VGS = 0 t0 20 V	-	11.7	-	nC
Rg	Gate input resistance	f=1 MHz open drain	-	7	-	Ω

Table 6: Switching energy (inductive load)

rabio or ormaning onergy (maderive read)						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon	Turn-on switching energy	$V_{DD} = 800 \text{ V}, I_{D} = 10 \text{ A}$	-	160	1	μJ
E _{off}	Turn-off switching energy	R_G = 6.8 Ω , V_{GS} = -2 to 20 V	-	90	1	μJ
Eon	Turn-on switching energy	$V_{DD} = 800 \text{ V}, I_{D} = 10 \text{ A}$	-	165	ı	μJ
E _{off}	Turn-off switching energy	R_G = 6.8 Ω , V_{GS} = -2 to 20 V T_J = 150 °C	-	100	-	μJ

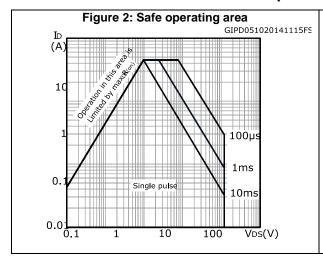
Table 7: Switching times

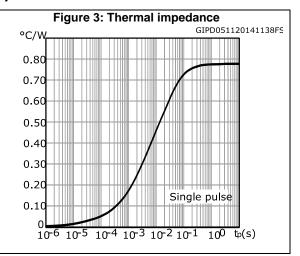
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d (on)} v	Turn-on delay time		-	10	-	ns
t _{f(V)}	Fall time	$V_{DD} = 800 \text{ V}, I_{D} = 10 \text{ A}$	-	17	-	ns
t _{d(off)} ∨	Turn-off delay time	$R_G = 0 \Omega$, $V_{GS} = 0 \text{ to } 20 \text{ V}$	-	27	-	ns
t _{r(V)}	Rise time		-	16	-	ns

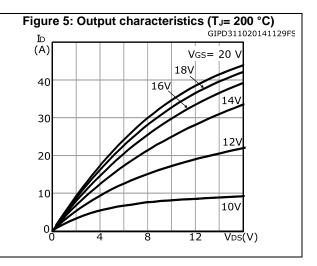
Table 8: Reverse SiC diode characteristics

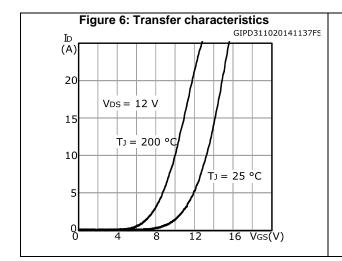
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V _{SD}	Diode forward voltage	I _F = 5 A, V _{GS} = -5 V	ı	3.6	1	V
t _{rr}	Reverse recovery time	I _{SD} = 10 A, V _{GS} = -5 V,	-	15	-	ns
Qrr	Reverse recovery charge	di/dt = 1650 A/µs	-	75	-	nC
I _{RRM}	Reverse recovery current	V _R = 800 V	-	8	-	Α

2.2 Electrical characteristics (curves)









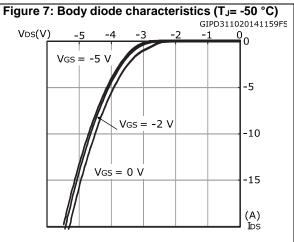


Figure 9: Body diode characteristics (TJ= 150 °C)

GIPD311020141338FS

VDS(V) -5 -4 -3 -2 -1 0

VGS = -5 V

VGS = -2 V

-5

-10

(A)

IDS

Figure 10: 3rd quadrant characteristics (T_J= -50 °C)

GIPD311020141343FS

VDS(V) -5 -4 -3 -2 -1 0 1

VGS = 0 V

VGS = 5 V

-20

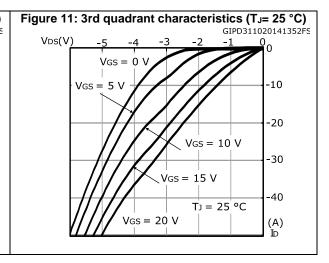
VGS = 15 V

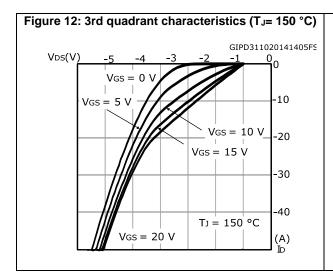
VGS = 15 V

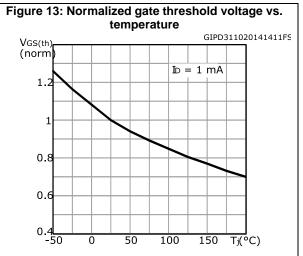
T_J = -50 °C

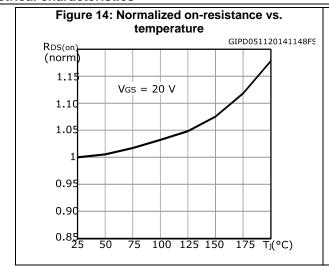
(A)

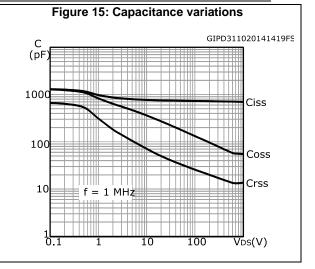
ID











3 **Package information**

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

3.1 HiP247 long leads package information

Figure 16: HiP247™ long leads package outline HEAT-SINK PLANE ÐΊA F2 BACK VIEW 7395426_7.0

Table 9: HiP247™ long leads package mechanical data

	ible 9: HIP247 ···· long lead	mm.	
Dim.	Min.	Тур.	Max.
А	4.90		5.15
D	1.85		2.10
E	0.55		0.67
F	1.07		1.32
F1	1.90		2.38
F2	2.87		3.38
G		10.90 BSC	
Н	15.77		16.02
L	20.82		21.07
L1	4.16		4.47
L2	5.49		5.74
L3	20.05		20.30
L4	3.68		3.93
L5	6.04		6.29
M	2.25		2.55
V		10°	
V1		3°	
V3		20°	
DIA	3.55		3.66

SCTWA20N120 Revision history

4 Revision history

Table 10: Document revision history

Date	Revision	Changes
07-Jun-2016	1	First release

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics - All rights reserved